

## Vishay General Semiconductor

COMPLIANT

HALOGEN

**FREE** 

## **Surface Mount Glass Passivated Rectifier**



**DO-214AB (SMC)** 

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	8.0 A				
V <sub>RRM</sub>	400 V, 600 V, 800 V, 1000 V				
I <sub>FSM</sub>	200 A				
I <sub>R</sub>	10 μΑ				
V <sub>F</sub> at I <sub>F</sub> = 8 A (T <sub>A</sub> = 125 °C)	0.87 V				
T <sub>J</sub> max.	150 °C				
Package	DO-214AB (SMC)				
Diode variations	Single die				

#### **FEATURES**

- Low profile package
- Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- · Low leakage current
- · High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

### TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

### **MECHANICAL DATA**

Case: DO-214AB (SMC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	S8CG	S8CJ	S8CK	S8CM	UNIT
Device marking code		8G	8J	8K	8M	
Maximum repetitive peak reverse voltage	$V_{RRM}$	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	400	600	800	1000	V
Marian and an atifical annual	I <sub>F(AV)</sub> (1)	8.0				Α
Maximum average forward rectified current	I <sub>F(AV)</sub> (2)		Α			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	200			А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150				°C

#### Notes

- (1) Mounted on aluminum PCB 30 mm x 30 mm with aluminum heatsink
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 4.0 A	- T <sub>A</sub> = 25 °C	- V <sub>F</sub> <sup>(1)</sup>	0.89	-	. V
	I <sub>F</sub> = 8.0 A			0.96	0.985	
	I <sub>F</sub> = 4.0 A	T <sub>A</sub> = 125 °C		0.78	-	
	I <sub>F</sub> = 8.0 A			0.87	0.935	
Reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	10	μΑ
	nated V <sub>R</sub>	T <sub>A</sub> = 125 °C		-	350	
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	4	-	μs
Typical junction capacitance	4.0 V, 1 MHz		$C_{J}$	79	-	pF

### Notes

 $^{(1)}$  Pulse test: 300  $\mu s$  pulse width; 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	S8CG	S8CJ	S8CK	S8CM	UNIT
Typical thermal resistance	R <sub>0</sub> JA (1)		°C/W			
Typical thermal resistance	R <sub>0JM</sub> (2)	9.5				C/ VV

#### Notes

(1) Free air, mounted on recommended PCB, 2 oz.pad area; thermal resistance R<sub>θJA</sub> - junction to ambient

 $^{(2)}$  Mounted on 30 mm x 30 mm Aluminum PCB, thermal resistance  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
S8CJ-M3/I	0.257	I	3500	13" diameter plastic tape and reel		
S8CJHM3/I (1)	0.257	I	3500	13" diameter plastic tape and reel		

### Note

(1) AEC-Q101 qualified

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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

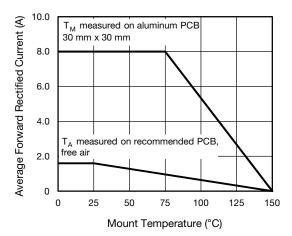


Fig. 1 - Forward Current Derating Curve

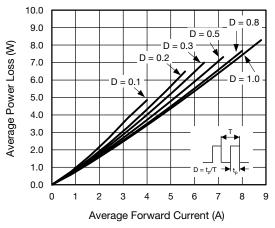


Fig. 2 - Average Power Loss Characteristics

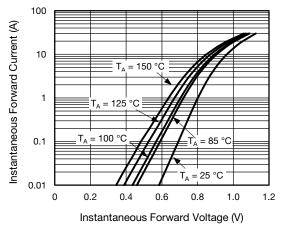


Fig. 3 - Typical Instantaneous Forward Characteristics

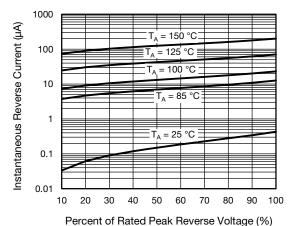


Fig. 4 - Typical Reverse Characteristics

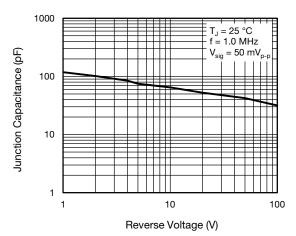


Fig. 5 - Typical Junction Capacitance

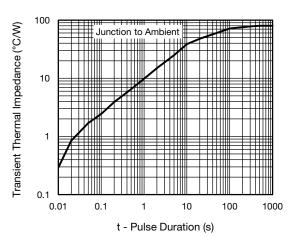


Fig. 6 - Typical Transient Thermal Impedance

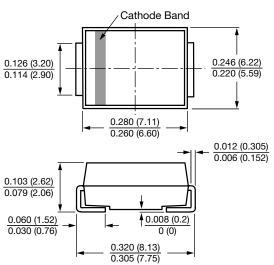


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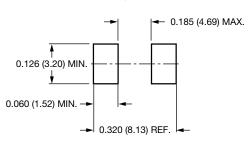
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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### **DO-214AB (SMC)**



### Mounting Pad Layout





## **Legal Disclaimer Notice**

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